TOSHIBA Field Effect Transistor Silicon P Channel MOS Type

# SSM3J01F

## **High Speed Switching Applications**

• Small package

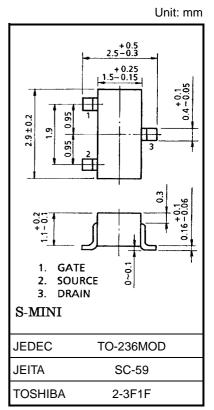
• Low on resistance: Ron =  $0.4 \Omega$  (max) (VGS = -4 V)

: Ron =  $0.6 \Omega$  (max) (VGS = -2.5 V)

• Low gate threshold voltage

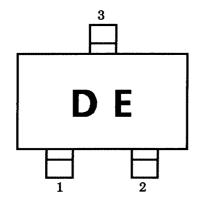
## **Maximum Ratings (Ta = 25°C)**

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		$V_{DS}$	-30	V	
Gate-source voltage		$V_{GSS}$	±10	V	
Drain current	DC	I <sub>D</sub>	-700	mA	
	Pulse	I <sub>DP</sub>	-1400		
Drain power dissipation (Ta = 25°C)		P <sub>D</sub>	200	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

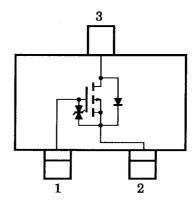


Weight: 0.012 g (typ.)

#### Marking



## **Equivalent Circuit**



### **Handling Precaution**

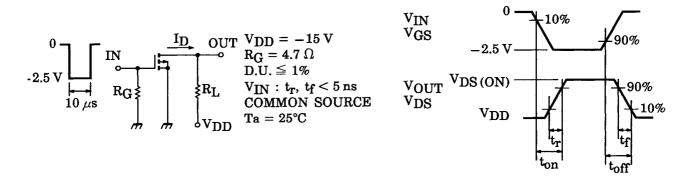
When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

#### **Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	_	_	±1	μΑ
Drain-source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-30	_	_	V
Drain cut-off curre	ent	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0$	_	_	-1	μА
Gate threshold vo	ltage	V <sub>th</sub>	$V_{DS} = -3 \text{ V}, I_D = -0.1 \text{ mA}$	-0.6	_	-1.1	V
Forward transfer admittance		Y <sub>fs</sub>   (Note)	$V_{DS} = -3 \text{ V}, I_D = -0.35 \text{ A}$	1.0	_	_	S
Drain-source ON resistance		R <sub>DS</sub> (ON )	$I_D = -0.35 \text{ A}, V_{GS} = -4 \text{ V}$	_	0.3	0.4	Ω
		(Note) I <sub>D</sub> :	$I_D = -0.35 \text{ A}, V_{GS} = -2.5 \text{ V}$	_	0.4	0.6	
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0, f = 1 MHz	_	240	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0, f = 1 MHz	_	24	_	pF
Output capacitance		Coss	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0, f = 1 MHz	_	94	_	pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -15 \text{ V}, I_D = -0.3 \text{ A}, \\ V_{GS} = 0 2.5 \text{ V}, R_G = 4.7 \Omega$	_	36	_	- ns
	Turn-off time	t <sub>off</sub>		_	37	_	

Note: Pulse test

### **Switching Time Test Circuit**



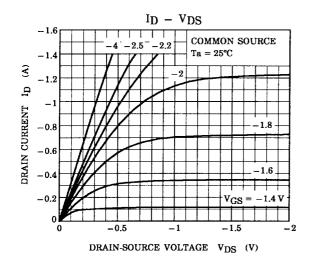
#### **Precaution**

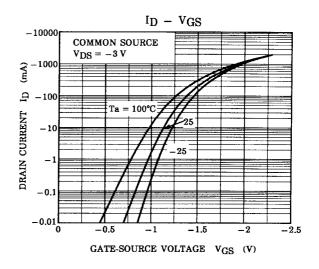
 $V_{th}$  can be expressed as voltage between gate and source when low operating current value is  $I_D$  =  $-100~\mu A$  for this product. For normal switching operation,  $V_{GS}$  (ON) requires higher voltage than  $V_{th}$  and  $V_{GS}$  (off) requires lower voltage than  $V_{th}$ .

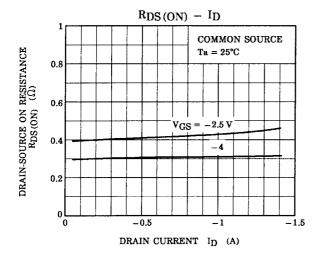
(Relationship can be established as follows:  $V_{GS (off)} < V_{th} < V_{GS (oN)}$ )

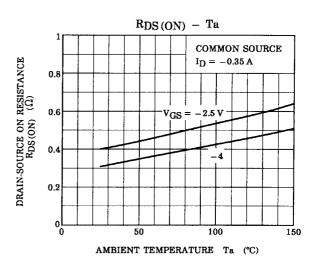
Please take this into consideration for using the device.

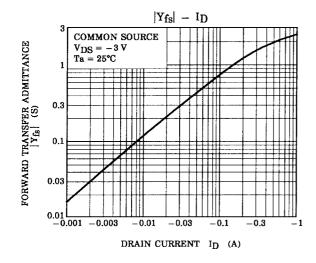
 $\ensuremath{V_{\mathrm{GS}}}$  recommended voltage of –2.5 V or higher to turn on this product.

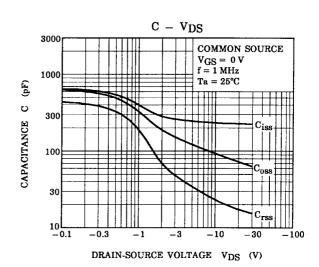




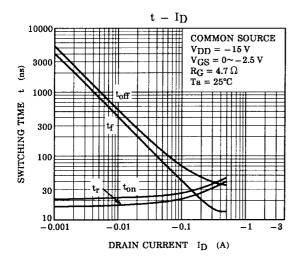


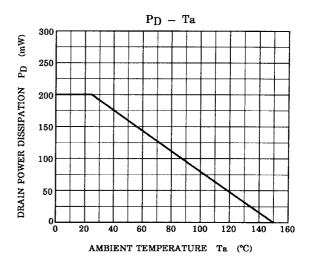






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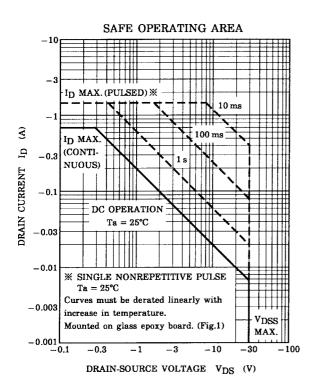




Figure 1 25.4 mm  $\times$  25.4 mm  $\times$  1.6 t (a Cu pad of 0.8 mm<sup>2</sup> area)

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